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FCD850N80Z / FCU850N80Z N-Channel SuperFET[®] II MOSFET

800 V, 6 A, 850 mΩ

Features

- Typ. R_{DS(on)} = 710 mΩ (Typ.)
- Ultra Low Gate Charge (Typ. Q_g = 22 nC)
- Low Eoss (Typ. 2.3 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 106 pF)
- 100% Avalanche Tested
- RoHS Compliant
- · ESD Improved Capability

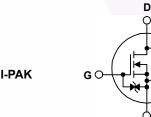
Applications

- AC DC Power Supply
- LED Lighting

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress.Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





Absolute Maximum Ratings T_C=25°C unless otherwise noted.

Symbol			FCD850N80Z FCU850N80Z	Unit	
V _{DSS}	Drain to Source Voltage	800	V		
V _{GSS}	Cata ta Sauraa Valtaga	- DC	±20	- V	
	Gate to Source Voltage	- AC	±30		
	Drain Current	- Continuous (T _C = 25 ^o C)	6	Α	
D	Drain Current	- Continuous (T _C = 100 ^o C)		3.8	A
I _{DM}	Drain Current	- Pulsed	(Note 1)	18	А
E _{AS}	Single Pulsed Avalanche Energ	114	mJ		
I _{AR}	Avalanche Current	1.2	Α		
E _{AR}	Repetitive Avalanche Energy (Note 1)			0.284	mJ
dv/dt	MOSFET dv/dt	100	V/ns		
	Peak Diode Recovery dv/dt	20			
P _D	Devues Dissingtion	(T _C = 25°C)	75	W	
	Power Dissipation	- Derate Above 25°C	0.6	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C

Thermal Characteristics

Symbol	Parameter	FCD850N80Z FCU850N80Z	Unit		
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	1.65	°C/W		
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	100	-0/10		

October 2014

FCD850N80Z FCD850N80Z D		Top Mark	Pac	ckage Packing Method Reel Siz		ze	Tape Wid	th C	Quantity		
		FCD850N80Z	Dł	PAK	Tape and Re	el	330 mm		16 mm	2	500 units
		IF	PAK Tube NA				NA		75 units		
Electrica	l Char	acteristics T _C = 25	5ºC unl	ess othe	erwise noted.						
Symbol		Parameter		Test Conditions				Min.	Тур.	Max.	Unit
Off Charac	teristic	2									
BV _{DSS}	I	Source Breakdown Volt	200	V	$0 \sqrt{1} = 1 \text{ m} \sqrt{1}$	- 259	2 C	800		_	V
ABV _{DSS}			$V_{GS} = 0 V, I_D = 1 mA, T_J = 25^{\circ}C$			000	-	-	V/°C		
ΔT _J	Breakdown Voltage Temperature Coefficient			$I_D = 1 \text{ mA}$, Referenced to 25° C				-	0.8	0.8 - '	
				V _{DS} =	800 V, V _{GS} = 0 V	/		-		25	
DSS	Zero Gate Voltage Drain Current		t	$V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 125^{\circ}\text{C}$				-	-	250	μΑ
GSS	Gate to	Gate to Body Leakage Current			$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$				-	±10	μA
On Charac	teristics	6									
V _{GS(th)}	Gate Th	reshold Voltage		$V_{GS} = V_{DS}, I_{D} = 0.6 \text{ mA}$				2.5	-	4.5	V
R _{DS(on)}	Static D	rain to Source On Resis	tance	V _{GS} = 10 V, I _D = 3 A			-	710	850	mΩ	
ĴFS	Forward	Transconductance		V_{DS} =	20 V, I _D = 3 A			-	3.5	-	S
)vnamic (baracto	ristics									
Dynamic C	1										
C _{iss}	-	Input Capacitance Output Capacitance Reverse Transfer Capacitance			− V _{DS} = 100 V, V _{GS} = 0 V, − f = 1 MHz			-	990	1315	
Coss	-							-	28	37	pF
C _{rss}									0.74	-	pF
C _{oss}	-	Output Capacitance			$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$				15	-	pF
Coss(eff.)		e Output Capacitance	_	$V_{\rm DS}$ = 0 V to 480 V, $V_{\rm GS}$ = 0 V			·	-	106	-	pF
Q _{g(tot)}		te Charge at 10V	_		640 V, I _D = 6 A,		-	-	22	29	nC
ସୁ _{gs}		Source Gate Charge	_	V _{GS} =	10 V			-	5	-	nC
Q _{gd}		Drain "Miller" Charge	_				(Note 4)	-	8.6	-	nC
ESR	Equivale	ent Series Resistance		f = 1 N	IHz			-	2.4	-	Ω
Switching	Charact	eristics									
								-	16	42	
d(on)		Irn-On Delay Time		V_{DD} = 400 V, I_D = 6 A, V_{GS} = 10 V, R_a = 4.7 Ω			_	10	30	ns	
r	Turn-On Rise Time Turn-Off Delay Time							40	90	ns	
d(off)		Fall Time			9			-	40	19	ns
f	Tuni-On						(Note 4)	-	4.5	19	115
Drain-Sou	rce Dioc	le Characteristics									
s	Maximur	n Continuous Drain to S	ource D	iode Fo	orward Current	-		-	-	6	Α
SM		n Pulsed Drain to Sourc						-	-	18	Α
V _{SD}	Drain to	Source Diode Forward \	/oltage	$V_{GS} =$	0 V, I _{SD} = 6 A			-	-	1.2	V
m	-	Recovery Time			0 V, I _{SD} = 6 A,			-	318	-	ns
<u>קרי</u>		Recovery Charge			= 100 A/μs		-	-	4.5	-	μC
otes:				1							
-		imited by maximum junction terr	perature.								
		25 Ω, Starting $T_J = 25^{\circ}C$									
		$_{D} \le BV_{DSS}$, Starting T _J = 25°C erating temperature typical chara	acteristics								
	singent of up	and the second sec									

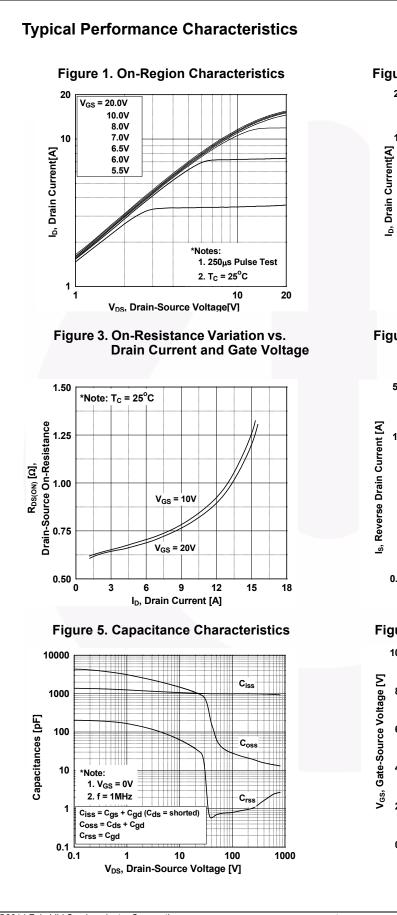


Figure 2. Transfer Characteristics

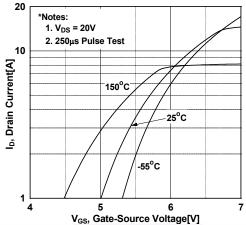


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

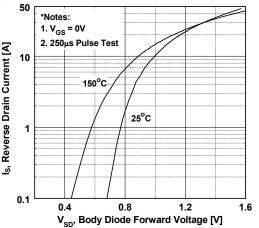
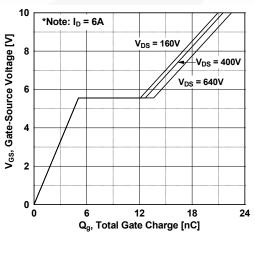
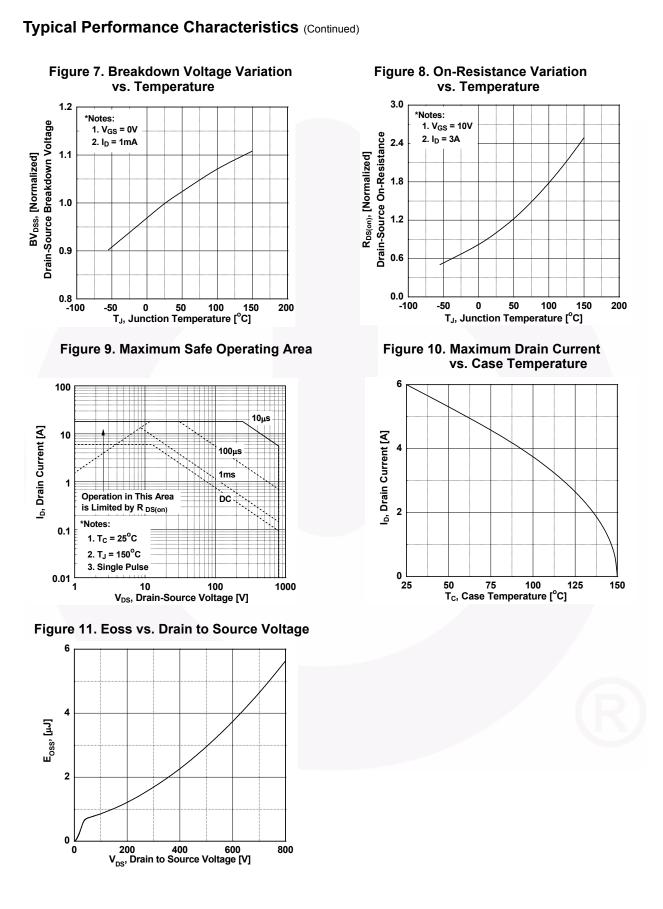
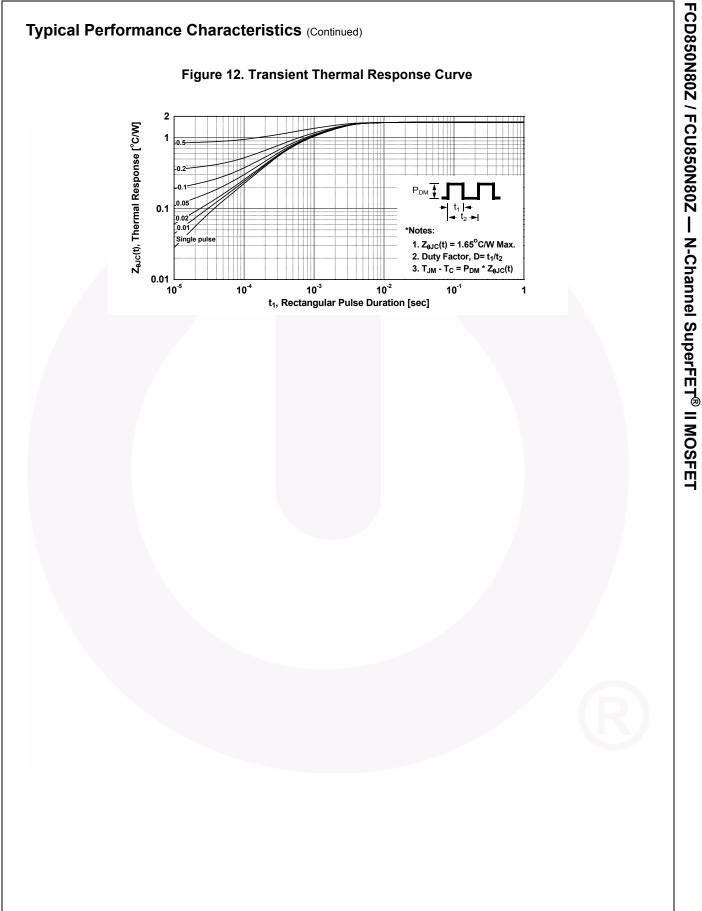
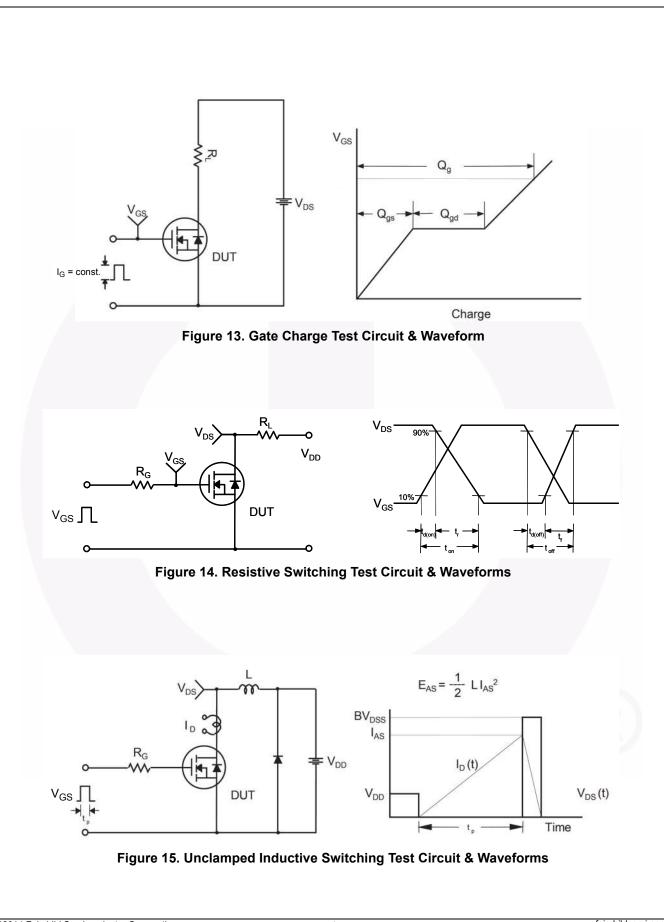


Figure 6. Gate Charge Characteristics

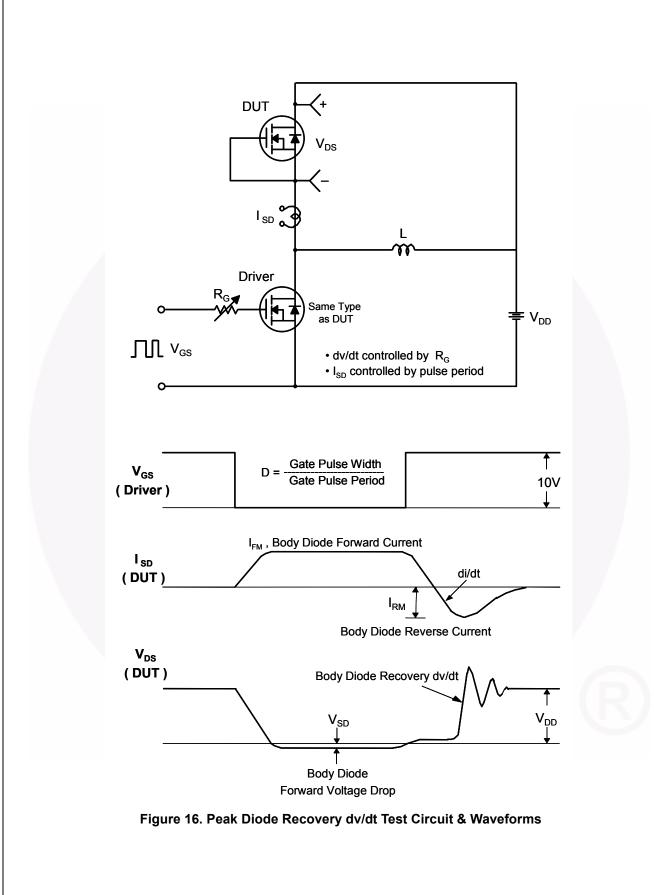


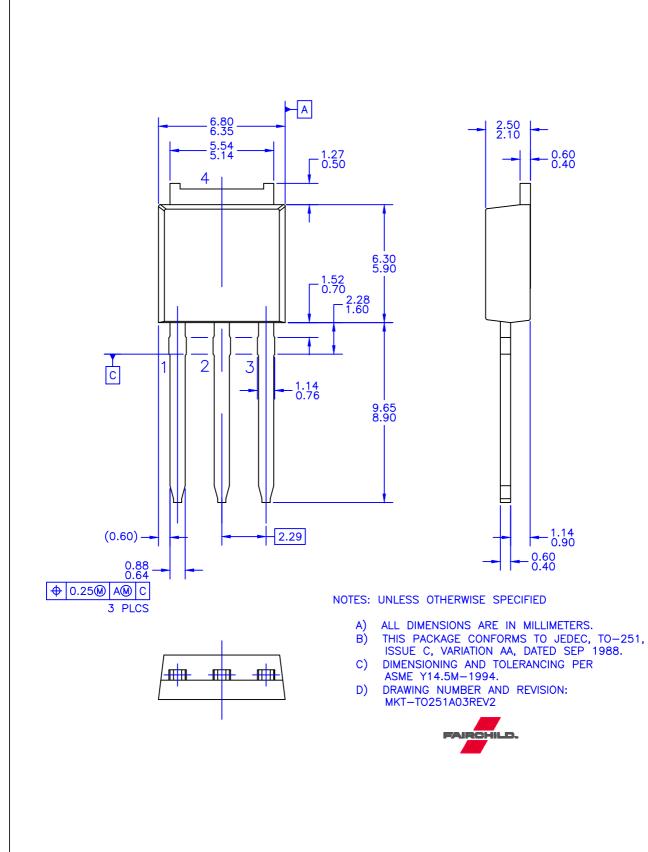


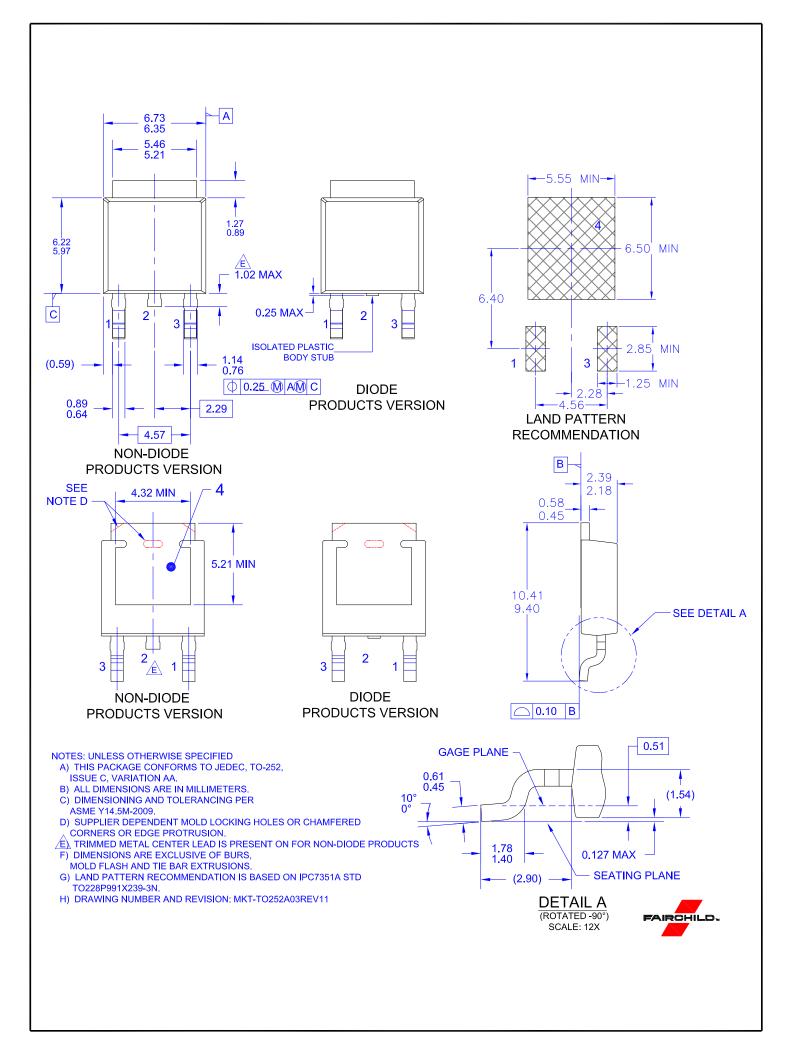




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